

Electronic Acknowledgement Receipt

EFS ID:	1147448
Application Number:	10699975
Confirmation Number:	5032
Title of Invention:	Mask layer and interconnect structure for dual damascene semiconductor manufacturing
First Named Inventor:	Isaiah O. Oladeji
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Filer Authorized By:	Charles W. Gaines
Attorney Docket Number:	JESSEN 7-1-4
Receipt Date:	09-AUG-2006
Filing Date:	02-NOV-2003
Time Stamp:	14:12:20
Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Request for Corrected Filing Receipt	Filing_Receipt.pdf	207703	no	3

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Information:	
Total Files Size (in bytes):	207703
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